



Updates on Impregnation and Epoxy Studies at FNAL

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9th HL-LHC CM Meeting — 16 October 2019



- Impregnation Procedure Review
- Investigation into T_g
- Process evolution
- Look at Shear Strength of Nb₃Sn Composite
- Mold Release Peel Testing

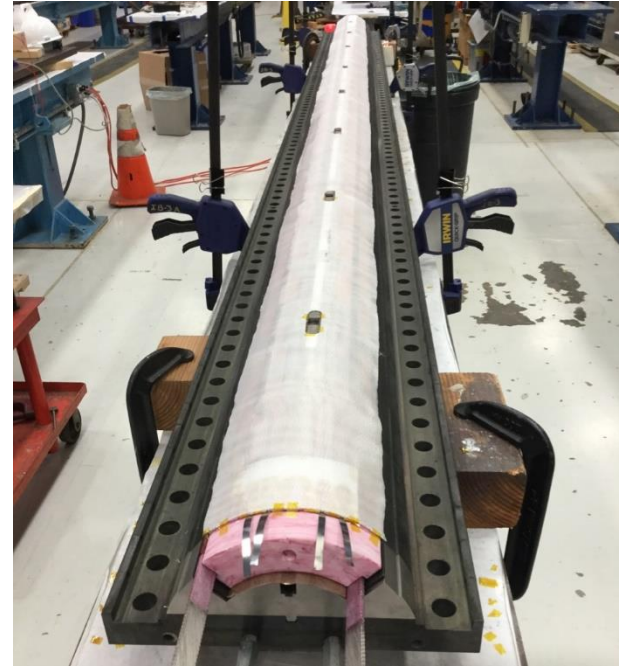
Coil Impregnation Process

- Goals of impregnation
 - Provide electrical insulation
 - Epoxy fills the voids in the glass insulation and allows for reasonably high insulation dielectric strength
 - Provide mechanical support
 - Epoxy fixes turns in place such that pre-load may be applied in a safe fashion and the magnet will maintain a magnetic cross section
 - Prevent conductor movement during powering to reduce magnet quenching
 - Allow for efficient handling of coils
 - Without impregnation Nb_3Sn coils are extremely delicate



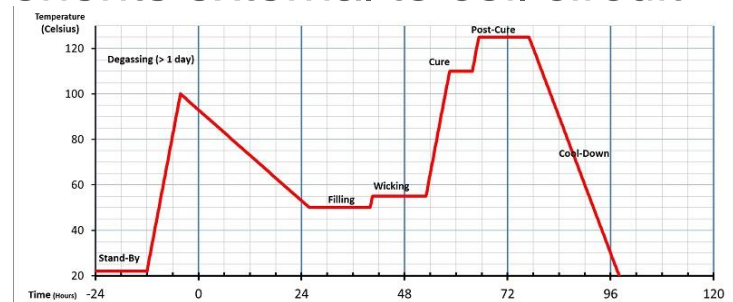
Impregnation Outline

- Coil Packaging
 - Mold release tooling
 - Install Quench Heaters
 - Install fiberglass
- Coil Leak Test



Coil Outgassing

- Coil is outgassed
 - QXF Coils are run through a pre-impregnation outgassing cycle: Fast ramp to 100C and long cool down (~30 Hours)
 - After outgassing cycle coil volume at inlet side is roughly 10X Chamber pressure
 - Tooling in ~30-90 mTorr (0.04-.12 mBar)
 - Ultimate chamber pressure depends on quality of door seal and behavior of other components external to coil circuit

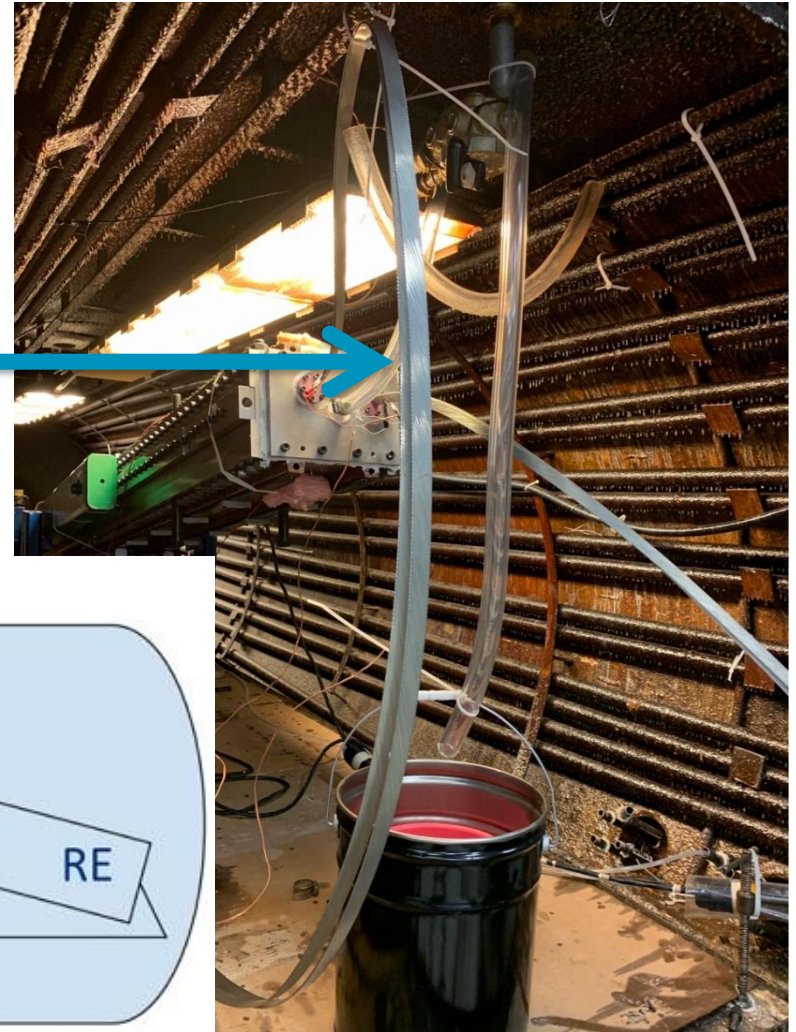
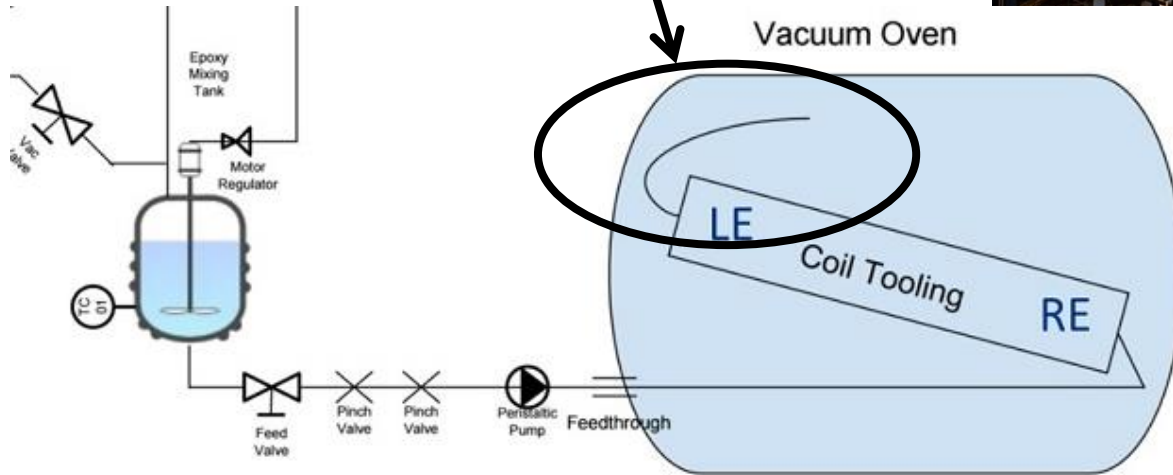


Filling

- Epoxy mixed and degassed for 1 hour at 55°C
- Injection into coil by Peristaltic pump at 10 ml/min effective flow rate
 - ~.75 liters of epoxy per meter of coil ~3.5 Liters of epoxy in the coil.
~5 hours of fill time
- After fill is complete, Chamber is let to atmosphere and any resin level change is recorded.

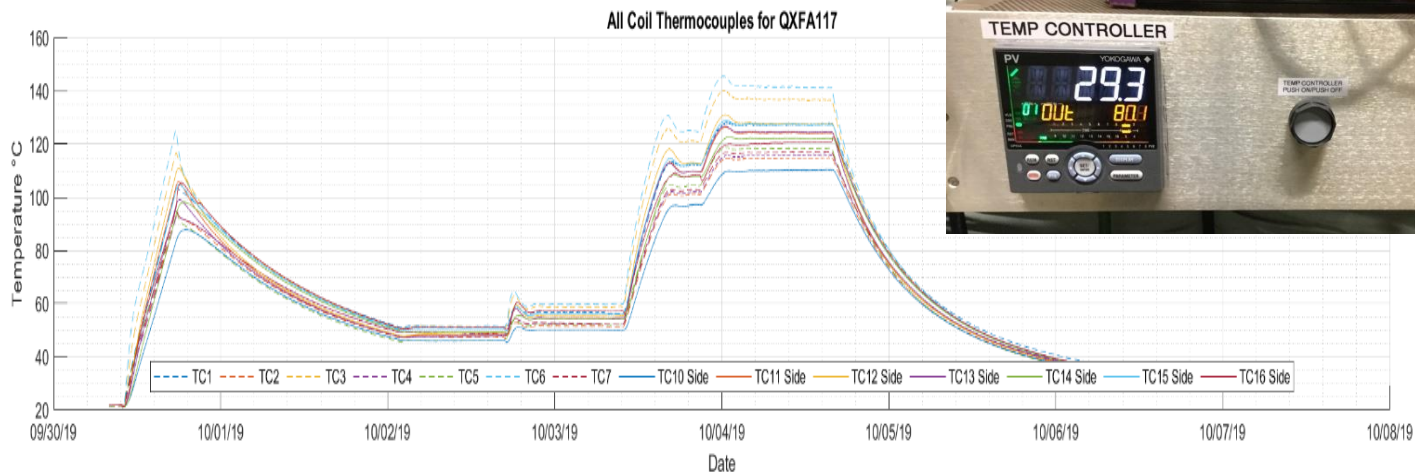
Coil in Vacuum Oven

300 ml Epoxy Reservoir
(Overflow tube)



Coil Curing

- Coil Curing follows CTD recipe
 - 110 °C for 5 hours
 - 125 °C for 16 hours
- Temperature control uses locally cooler area to drive tooling



Process Evolution

- Throughout LARP and AUP, we have been seeking to reduce variability and risk from coil to coil by
 - Reducing un-necessary steps
 - Integrating fixed processes
 - Reducing technician fabricated or configured items
 - Reducing sensitivity to process variables



Process Evolution: Feedthroughs and Plumbing

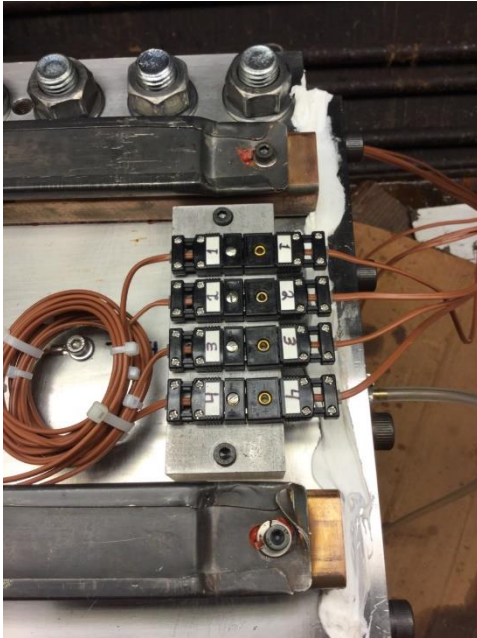
- All “valves” between epoxy tank and coil are of the pinch type.
- No breaks in line with semi-disposable feedthrough design
- Herbie Clips are handy and disposable. They avoid some of the troubles of hose clamps



Process Evolution: Instrumentation

Thermocouples and wiring

Instrumentation Thermocouples and wiring



Robust, Permanently mounted thermocouples



Well-Dressed cabling and wire routing



Improved granularity on measurement.

- Soon to come: Permanent, robust mounting



Coming Next Coil: automatically logged vacuum gages

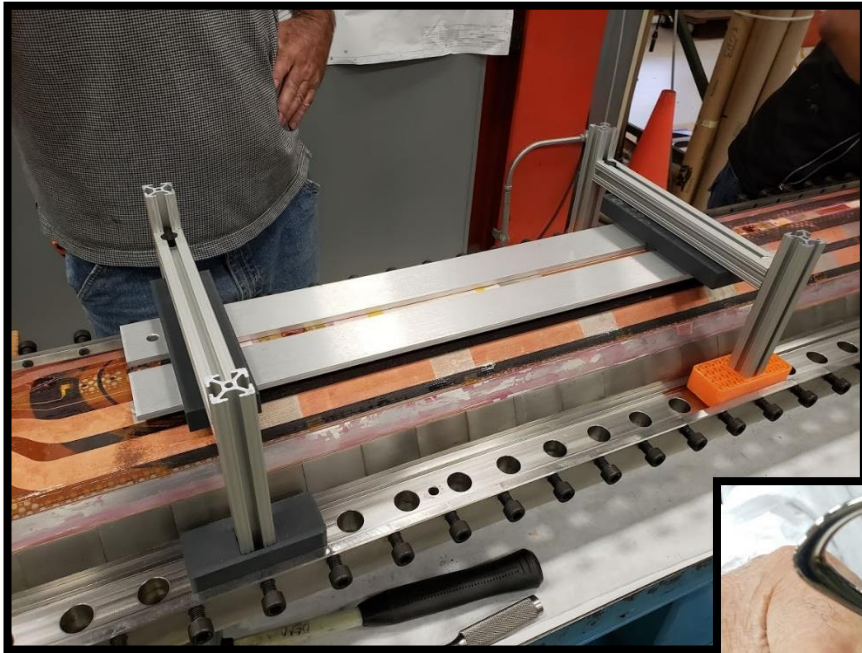
Process Evolution: Mixing and Degassing

- A Bigger Step
 - A purpose built mixing-degassing vessel is due next week.
 - Integrated system
 - Less user configuration required



Process Evolution: Coil Clean Up

Pole Trimming Fixture

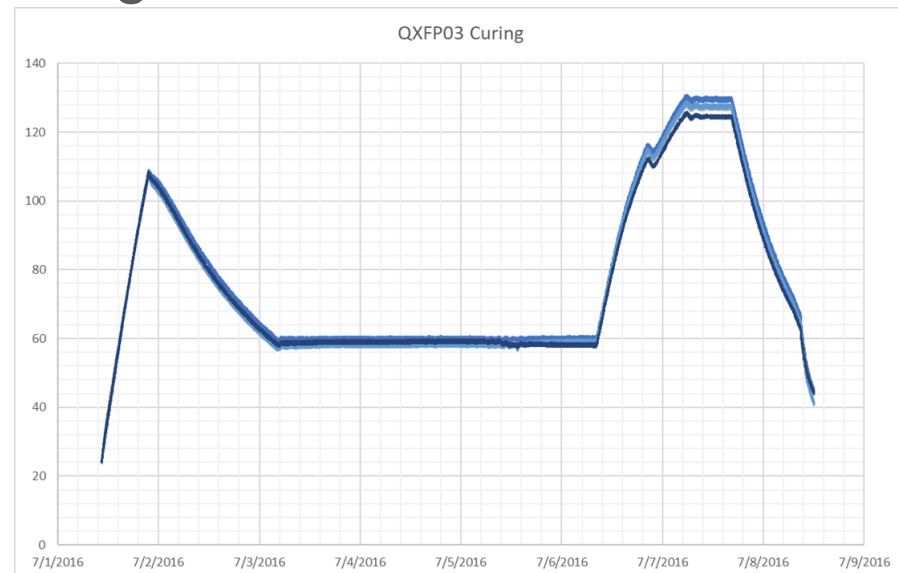


Midplane Trimming Fixture



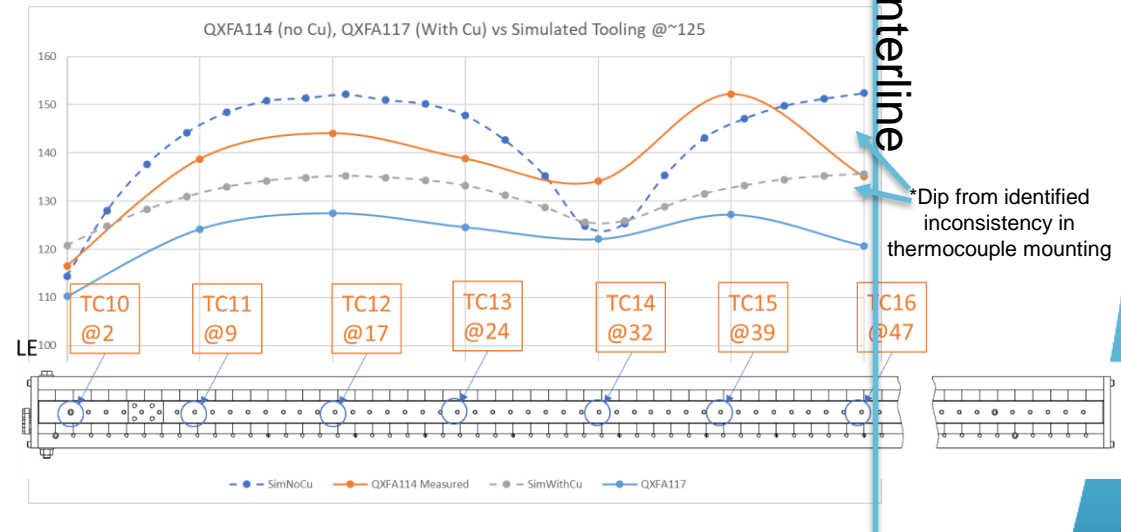
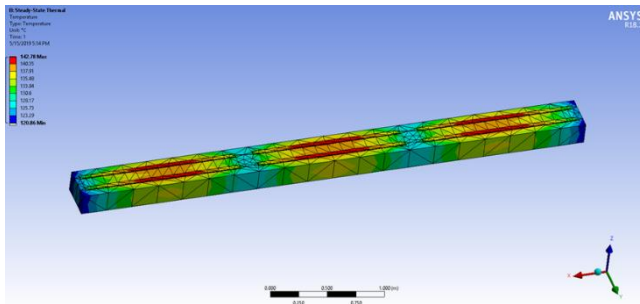
Coil Temperature Distribution

- Tooling is long and mostly has essentially Fixed power to mass and cross section
 - Except the ends
 - So we added a little insulation to compensate for added heat loss
 - Things generally look good



But conditions were different than assumed

- Periodic heaters and laminated blocks make for a worse than originally anticipated temperature distribution
 - Important to sample at $>$ Nyquist rate
- Added copper bars (old magnet conductor) to double longitudinal thermal conductivity (and roughly halve gradients).

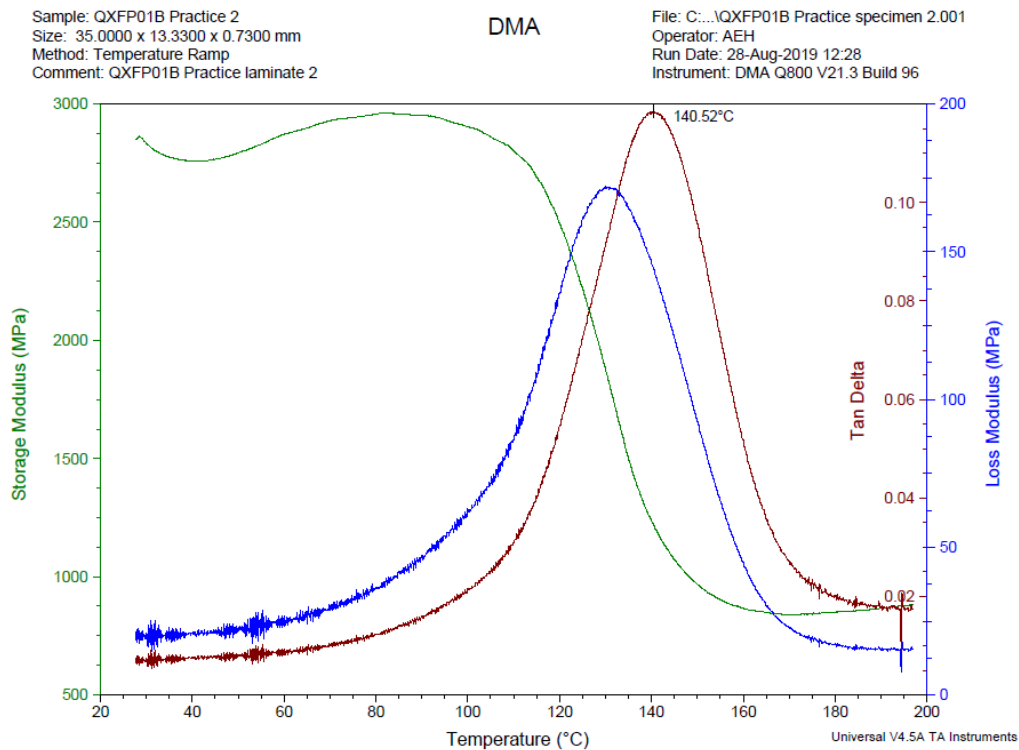


Examining Tg as a result of the above

- Use DSC and DMA tests to determine Tg along the length of coils QXFP03 and QXFP04 from magnet MQXFP1b.
 - Investigate possible impregnation process differences
 - Possibly use DSC for impregnation QA/QC
- DSC and DMA tests have been performed on cable insulation between turns from QXFP1b. DSC results were not usable from this source.
- A DSC test using a sample from the coil OD of QXFA108 along the titanium pole was successful.
- Determine the Tg offset between DMA and DSC.
- Side note: High Tg may not be desired as it results in larger differential thermal stresses.

DMA Test Results

- CTD101K Tg = 140°C ± 5°C based on DMA test.*
- DSC has an offset from DMA and will be established after coil sample testing.



DMA Samples
from QXFP1b

* Paul Fabian, VP of Operations, CTD

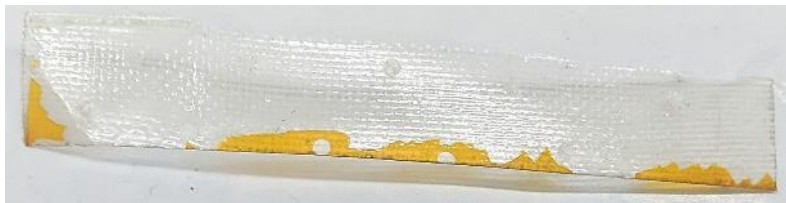
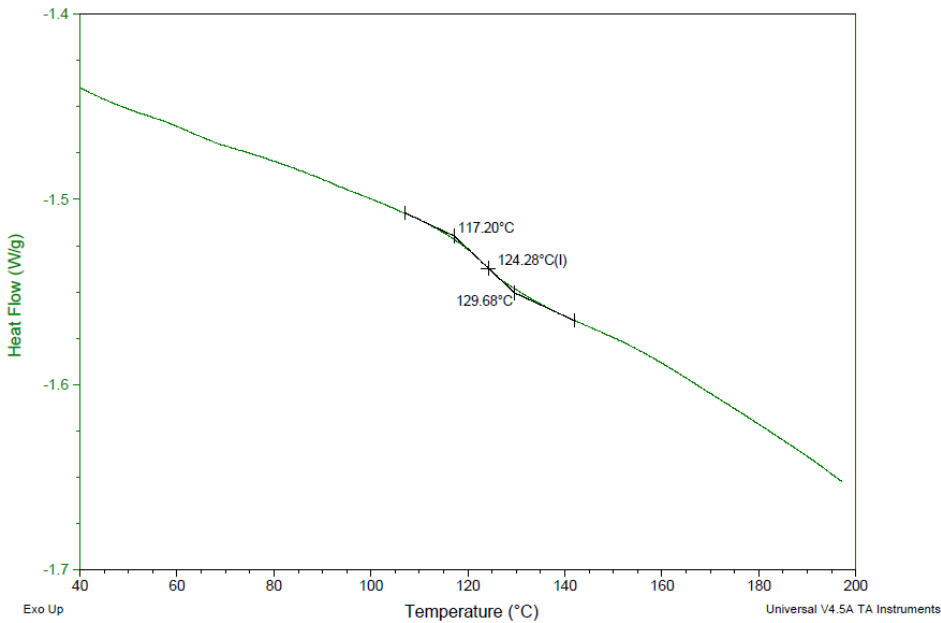
DSC Test Results

QXFA108 sample, $T_g=124.3^\circ\text{C}$

Sample: QXFA 108-2
Size: 18.2000 mg
Method: Ramp
Comment: QXFA 108 glass composite

DSC

File: C:\Users\ahaight\Desktop\QXFA 108-2.001
Operator: AEH
Run Date: 04-Sep-2019 10:40
Instrument: DSC Q20 V24.11 Build 124



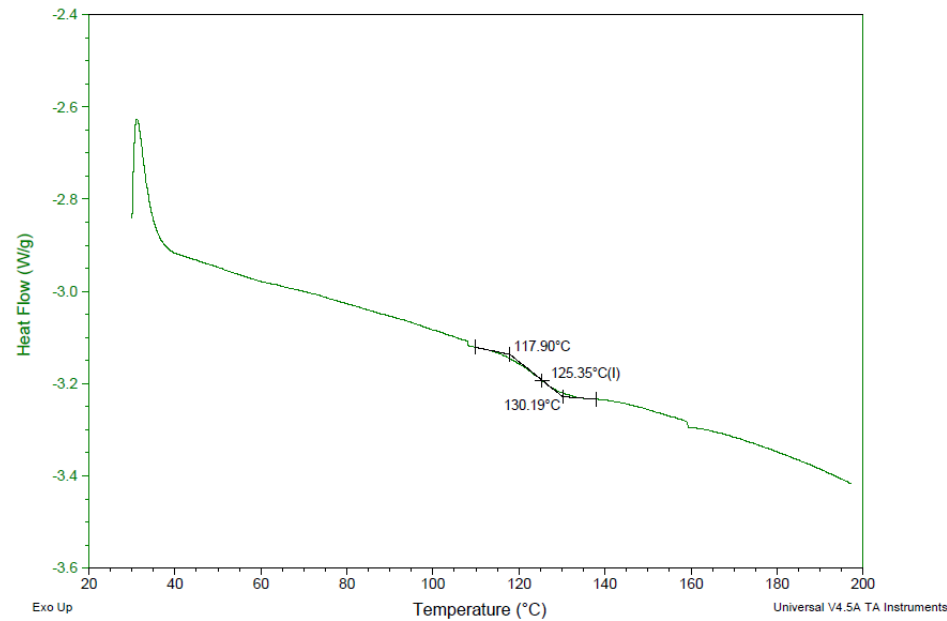
DSC Sample from QXFA108

CTD-101K neat resin, $T_g= 125.4^\circ\text{C}$

Sample: CTD-101K
Size: 8.4000 mg
Method: Ramp
Comment: Cured CTD-101K 7419-007

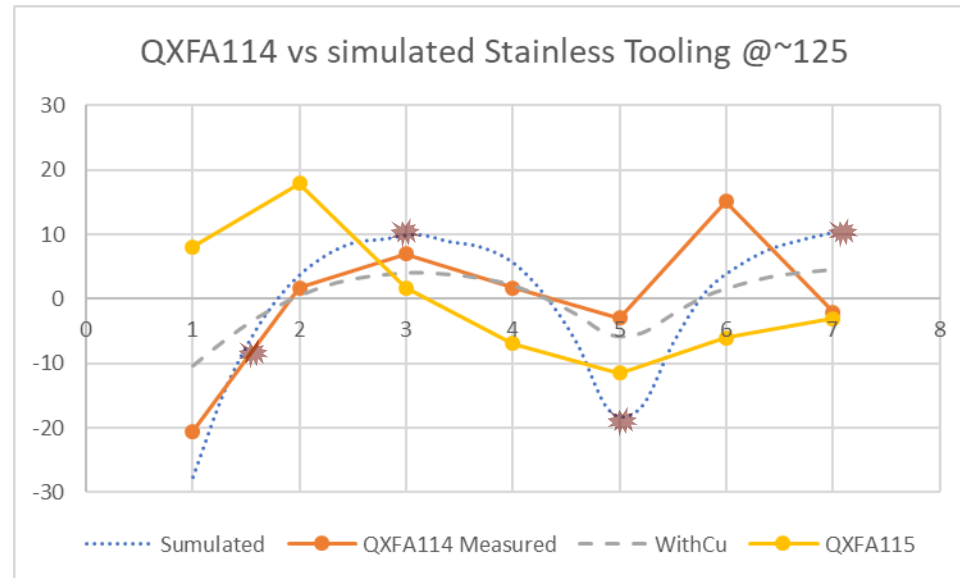
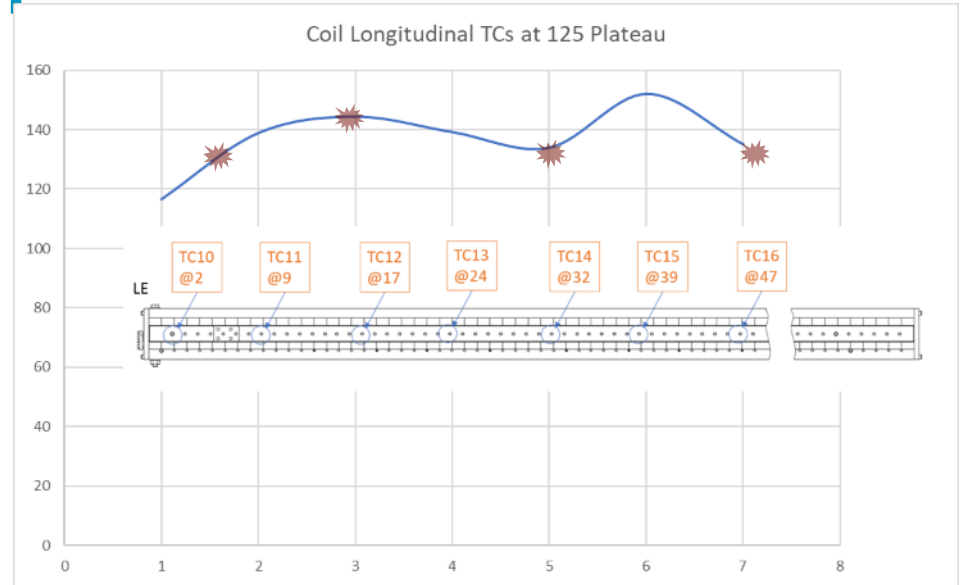
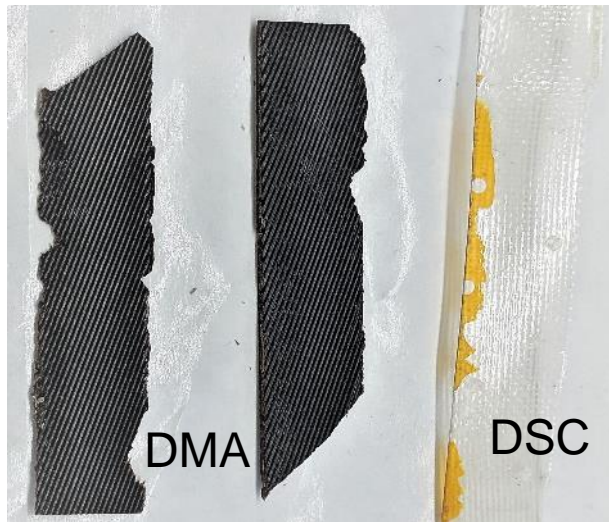
DSC

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Run Date: 01-May-2019 09:04
Instrument: DSC Q20 V24.11 Build 124



QXFP Sample Locations

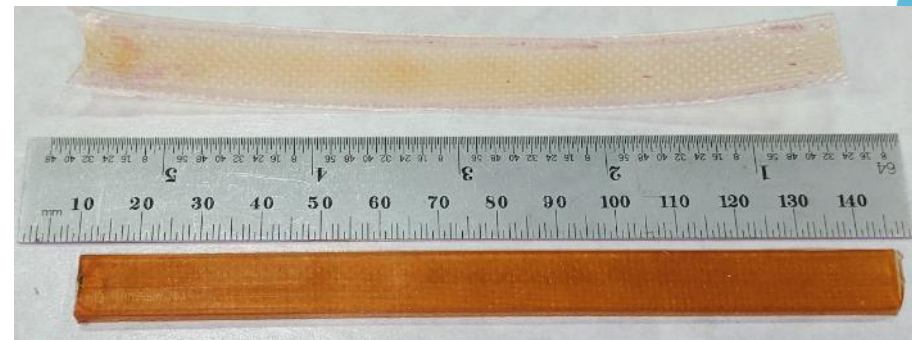
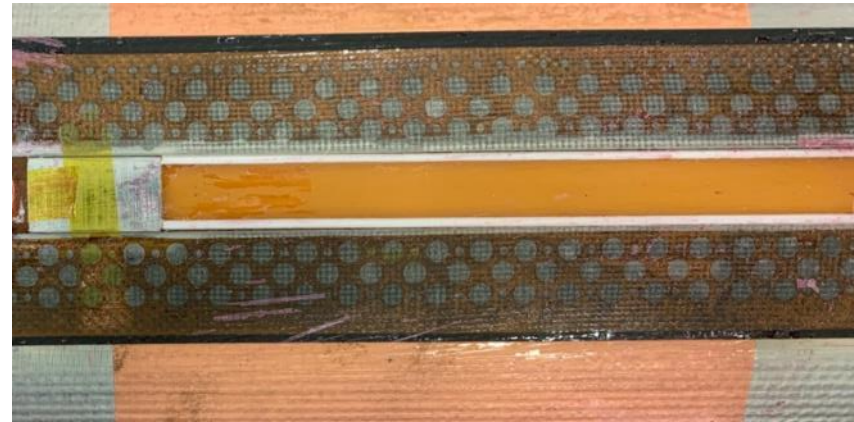
- Obtain 7 samples from high and low temperature locations along the length of the coil
 - DMA – between turns
 - DSC – along pole OD



Neat Resin Sample From QXFA116



- Epoxy samples available from coil lead end, center, and return end.
- Neat resin sample cross section:
10.3 mm x 3.4 mm



Tg Summary & Plan

- Preliminary DMA test results indicate coil Tg within tolerance.
- Developed viable samples from existing coils
 - Destructive test
 - Cable insulation between turns
 - Non-destructive tests
 - Neat resin samples from coil OD alignment slot
 - S2 glass from coil OD
- Plan
 - Obtain 14 samples along the length from coils QXFP03 & QXFP04
 - 7x samples for DSC
 - 7x samples for DMA
 - Test neat resin samples from QXFA116
 - 3x samples for DSC
 - 3x samples for DMA
 - Finalize test sample count (34) and submit purchase requisition for testing at CTD.

Other Testing: Short Beam Test

Why Short Beam Shear Testing

An appropriate test to quantify any changes in mechanical performance

- Binder volume is small so rule of mixtures tells us that modulus is unlikely to be affected.
- Compressive behavior is dominated by cable properties
- Tensile just wont work
- Shear
 - Binder is likely to affect interface behavior, therefore shear properties
 - Generally shear samples are complicated geometry that can not be realized with cable
 - Short Beam strength uses a symmetric beam with a span to thickness ration of ~4.
 - This is do-able

ASTM Designation: D 2344/D 2344M – 00¹

Standard Test Method for Short-Beam Strength of Polymer Matrix Composite Materials and Their Laminates¹

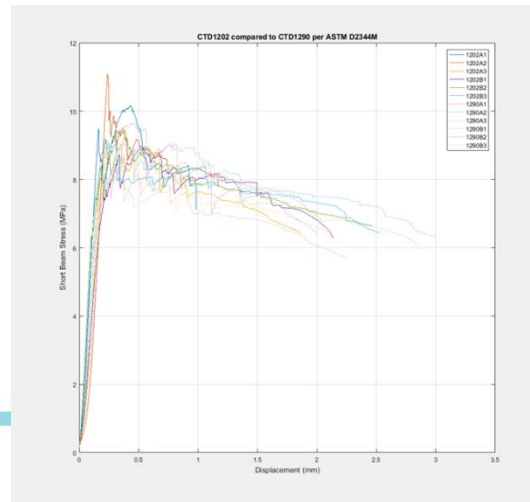
This standard is issued under the fixed designation D 2344/D 2344M; the number immediately following the designation indicates the year of original adoption or, in the case of revision, the year of last revision. A number in parentheses indicates the year of last approval. A superscript epsilon (ϵ) indicates an editorial change since the last revision or approval.

¹ Note—The title has been editorially corrected in November 2000.

1. Scope

1.1 This test method determines the short-beam strength of high-modulus fiber-reinforced composite materials. The specimen is a short beam machined from a curved or a flat laminate up to 6.00 mm [0.25 in.] thick. The beam is loaded in shear across boundaries.

D 5229/D 5229M Test Method for Moisture Properties and Equilibrium Conditioning of Fiber Composite Materials⁴
D 5687/D 5687M Guide for Preparation of F Panels with Processing Guidelines for Specimens⁴



	Average	σ	CV
1202	9.68 MPa	0.811 MPa	8.37%
1290	8.91 MPa	0.502 MPa	5.18%

Observations from SBS Testing

Shear Testing and Energy Release

Assuming that $K \approx$ constant and some basic spring stuff and conserving energy:

$$F=kx$$

$$x=F/k$$

$$E=1/2*k*x^2$$

$$E=1/2*k*F^2/k^2$$

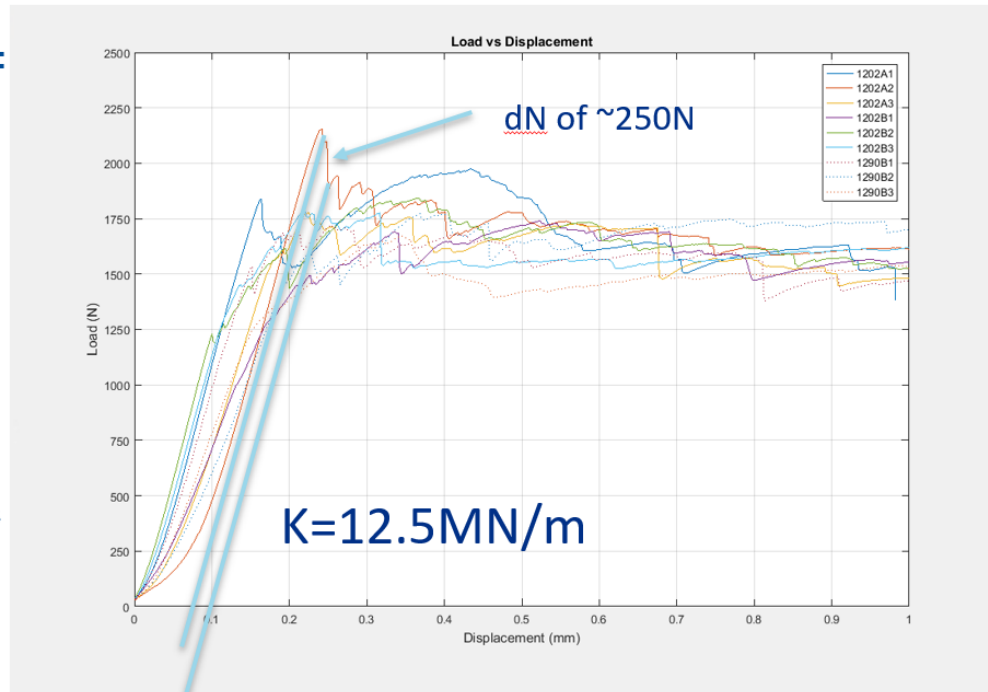
$$=1/(2k)*F^2$$

$$\Delta E = \frac{1}{2k} (F_1^2 - F_2^2)$$

In the highlighted event, the energy release is around 79 mJ

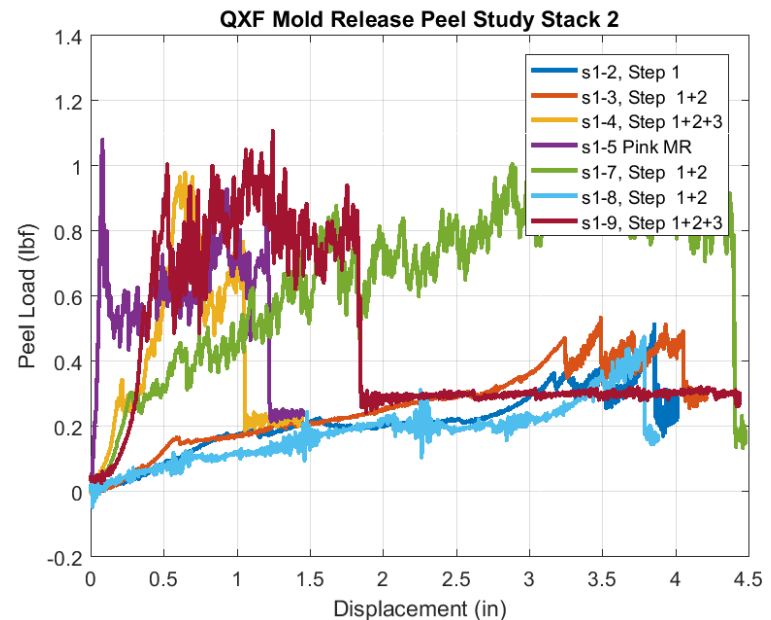
We could assume that the energy is release in the area of the delamination which could be considered at a minimum of ~80 uJ/mm²

Planning on reevaluating from a fracture mechanics approach if applicable



Mold Release Peel Testing

- Some recent coils have exhibited adhesion of the coil mid-plane to the impregnation tooling when demolding.
- A Quick comparison of peel strengths of various states of mold release was completed
- Conclusion: Mold release works well when applied in normal circumstances. Teflon works better.



Conclusions

- The FNAL Impregnation process has been evolving to reduce variability and risk
- Process observations have led to additional understanding of system behavior and informed process changes to reduce variability
- We get to learn things by building coils and investigating behavior